



## Multiscale Characterization and Computational Modeling/Simulation of Metallic Materials

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submissions:

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### Message from the Guest Editors

Metallic materials have been used in space, transportation, energy production, industry, and other fields. The application potential of engineering materials depends on their properties for the considered use. To deepen the understanding of the relationships between the structure, properties, or functions of materials, multiscale experimental techniques have been developed, including advanced macro-mechanical testing such as tensile, compressive, fatigue, impact, and creep loadings, as well as microstructural characterization. In addition, nano and atomistic approaches, including density functional theory modeling, first-principles modeling, molecular dynamics simulation and finite element simulation, have also been developed to probe the fundamental deformation mechanisms of materials.

This Special Issue aims to cover recent advances and developments in the multiscale characterization and computational modeling/simulation of metallic materials. This issue will collect quality papers providing a sound base in the field for present and future scientists dealing with the enhancement of metallic materials properties for specific high-end applications.





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## Message from the Editor-in-Chief

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